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Skyworks Captures Initial SkyOne™ Design Wins

World's Most Highly Integrated Front-end Solution Reduces Complexity, Size and Time-to-Market for Demanding Advanced Mobile Applications

BARCELONA, Spain--(BUSINESS WIRE)--Feb. 25, 2013-- Skyworks Solutions, Inc. (NASDAQ: SWKS), an innovator of high performance analog semiconductors enabling a broad range of endmarkets, today announced that several leading OEMs and smartphone providers are leveraging the company's highly customizable, fully optimized SkyOne™ front end solution. The SkyOne™ platform, which integrates all RF and analog content between the transceiver and antenna, reduces complexity, size and time-to-market for customers with demanding architectures for advanced mobile applications.

Utilizing Skyworks' full technology portfolio and advanced multichip module capabilities including proprietary shielding and packaging, SkyOne™ is the world's first semiconductor device to condense multiband power amplifiers and high throw switches along with all associated filtering, duplexing and control functionality into a single, ultra-compact package--all in less than half the area of the industry's most advanced approach. At the same time, this groundbreaking solution provides the world's best linearity and power added efficiency for smart RF integration. As a result, SkyOne™ offers smartphone, tablet and ultrabook OEMs improved efficiency, drastically reduced RF paths, ease of implementation and a scalable platform as bands increasingly proliferate worldwide.

"Consumer demand for increasingly thinner mobile platforms with increased talk and data access time is creating unprecedented analog and RF complexity as well as harmonic coexistence issues. Skyworks is delighted to solve this system challenge with our breakthrough SkyOne™ platform," said Liam K. Griffin, executive vice president and corporate general manager at Skyworks. "SkyOne™ is a proven architecture that optimizes performance beyond what is possible with existing approaches and incorporates all 2G, 3G and 4G/LTE protocols enabling seamless global roaming and extended battery life. Incorporating Skyworks' arsenal of tested and patented technologies and leveraging GaAs, SOI, SiGe and CMOS processes, SkyOne™ can be modulated and customized depending upon the system requirements and roadmaps of each OEM.

About the SkyOne™ Platform

SkyOne™ solutions incorporate the field proven SKY77619, Skyworks' high efficiency, multimode power amplifier module already in volume production with multiple customers. Further, the highly flexible solution contains a common footprint that can be implemented by all of the world's carriers and in various regions. Skyworks will be sampling third generation solutions next month and is already developing fifth generation architectures with multiple OEMs.

Specific SkyOne™ Devices

Sampling now, these second generation, hybrid, multimode, multiband, patented front-end modules with low insertion loss support 2.5/3G/4G handsets and operate efficiently in quad-band GSM, GPRS, EDGE, WCDMA, HSPA and LTE modes. The ultra compact, 7 x 9.8 x 1.05 millimeter packaged FEMs consist of a GSM800/EGSM900 power amplifier block (PA), a DCS1800/PCS1900 PA block, separate WCDMA blocks operating in the low and high bands, logic control block for multiple power control levels as well as band-enable functions in cellular and universal mobile telecommunications system. Radio frequency I/O ports are internally matched to minimize external components while extremely low leakage current maximizes handset standby time. The InGaP/GaAs die and passive components are mounted on a multi-layer laminate substrate and the assembly encapsulated in plastic overmold.

[SKY78010](#) (Bands I, II, IV, V, VIII)

[SKY78011](#) (Bands I, II, III, V, VIII)

Skyworks at Mobile World Congress

Skyworks will be showcasing its product portfolio in Hall 6, Booth E24 (6E24) at Mobile World Congress being held February 25 – 28, 2013.

About Skyworks

Skyworks Solutions, Inc. is an innovator of high performance analog semiconductors. Leveraging core technologies, Skyworks supports automotive, broadband, cellular infrastructure, energy management, GPS, industrial, medical, military, wireless networking, smartphone and tablet applications. The Company's portfolio includes amplifiers, attenuators, circulators, demodulators, detectors, diodes, directional couplers, front-end modules, hybrids, infrastructure RF subsystems, isolators, lighting and display solutions, mixers, modulators, optocouplers, optoisolators, phase shifters, PLLs/synthesizers/VCOs, power dividers/combiners, power management devices, receivers, switches and technical ceramics.

Headquartered in Woburn, Mass., Skyworks is worldwide with engineering, manufacturing, sales and service facilities throughout Asia, Europe and North America. For more information, please visit Skyworks' Web site at: www.skyworksinc.com.

Safe Harbor Statement

This news release includes "forward-looking statements" intended to qualify for the safe harbor from liability established by the Private Securities Litigation Reform Act of 1995. These forward-looking statements include without limitation information relating to future results and expectations of Skyworks (including without limitation certain projections and business trends). Forward-looking statements can often be identified by words such as "anticipates," "expects," "forecasts," "intends," "believes," "plans," "may," "will," or "continue," and similar expressions and variations or negatives of these words. All such statements are subject to certain risks, uncertainties and other important factors that could cause actual results to differ materially and adversely from those projected, and may affect our future operating results, financial position and cash flows.

These risks, uncertainties and other important factors include, but are not limited to: uncertainty regarding global economic and financial market conditions; the susceptibility of the semiconductor industry and the markets addressed by our, and our customers', products to economic downturns; the timing, rescheduling or cancellation of significant customer orders and our ability, as well as the ability of our customers, to manage inventory; losses or curtailments of purchases or payments from key customers, or the timing of customer inventory adjustments; the availability and pricing of third party semiconductor foundry, assembly and test capacity, raw materials and supplier components; changes in laws, regulations and/or policies, including the possibility of expiring tax cuts combined with mandatory reductions in federal spending, in the United States that could adversely affect either (i) the economy and our customers' demand for our products or (ii) the financial markets and our ability to raise capital; our ability to develop, manufacture and market innovative products in a highly price competitive and rapidly changing technological environment; economic, social and political conditions in the countries in which we, our customers or our suppliers operate, including security and health risks, possible disruptions in transportation networks and fluctuations in foreign currency exchange rates; fluctuations in our manufacturing yields due to our complex and specialized manufacturing processes; delays or disruptions in production due to equipment maintenance, repairs and/or upgrades; our reliance on several key customers for a large percentage of our sales; fluctuations in the manufacturing yields of our third party semiconductor foundries and other problems or delays in the fabrication, assembly, testing or delivery of our products; our ability to timely and accurately predict market requirements and evolving industry standards, and to identify opportunities in new markets; uncertainties of litigation, including potential disputes over intellectual property infringement and rights, as well as payments related to the licensing and/or sale of such rights; our ability to rapidly develop new products and avoid product obsolescence; our ability to retain, recruit and hire key executives, technical personnel and other employees in the positions and numbers, with the experience and capabilities, and at the compensation levels needed to implement our business and product plans; lengthy product development cycles that impact the timing of new product introductions; unfavorable changes in product mix; the quality of our products and any remediation costs; shorter than expected product life cycles; problems or delays that we may face in shifting our products to smaller geometry process technologies and in achieving higher levels of design integration; and our ability to continue to grow and maintain an intellectual property portfolio and obtain needed licenses from third parties, as well as other risks and uncertainties, including, but not limited to, those detailed from time to time in our filings with the Securities and Exchange Commission.

The forward-looking statements contained in this news release are made only as of the date hereof, and we undertake no obligation to update or revise the forward-looking statements, whether as a result of new information, future events or otherwise.

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Photos/Multimedia Gallery Available: <http://www.businesswire.com/multimedia/home/20130224005225/en/>

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